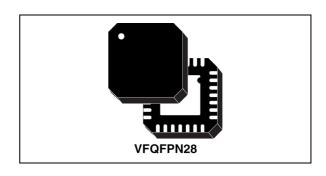


## Multi-band RF frequency synthesizer with integrated VCOs

### **Features**

- Integer-N frequency synthesizer
- Dual differential integrated VCOs with automatic center frequency calibration:
  - 2500 3050 MHz (direct output)
  - 4350 5000 MHz (direct output)
  - 1250 1525 MHz (internal divider by 2)
  - 2175 2500 MHz (internal divider by 2)
  - 625 762.5 MHz (internal divider by 4)
  - 1087.5 1250 MHz (internal divider by 4)
- Excellent integrated phase noise
- Fast lock time: 150µs
- Dual modulus programmable prescaler (16/17 or 19/20)
- 2 programmable counters to achieve a feedback division ratio from 256 to 65551 (prescaler 16/17) and from 361 to 77836 (prescaler 19/20).
- Programmable reference frequency divider (10 bits)
- Phase frequency comparator and charge pump
- Programmable charge pump current
- Digital lock detector
- Dual digital bus interface: SPI and I<sup>2</sup>C bus (fast mode) with 3 bit programmable address (1100A<sub>2</sub>A<sub>1</sub>A<sub>0</sub>)
- 3.3 V power supply
- Power down mode (hardware and software)
- Small size exposed pad VFQFPN28 package5 mm x 5 mm x 1.0 mm
- Process: BICMOS 0.35 µm SiGe



### **Applications**

- 2.5G and 3G Cellular infrastructure equipment
- CATV equipment
- Instrumentation and test equipment
- Other wireless communication systems

### **Description**

The STMicroelectronics STW81103 is an integrated RF synthesizer with voltage controlled oscillators (VCOs). Showing high performance, high integration, low power, and multi-band performances, STW81103 is a low cost one chip alternative to discrete PLL and VCOs solutions.

STW81103 includes an Integer-N frequency synthesizer and two fully integrated VCOs featuring low phase noise performance and a noise floor of -155dBc/Hz. The combination of wide frequency range VCOs (thanks to centerfrequency calibration over 32 sub-bands) and multiple output options (direct output, divided by 2 or divided by 4) allows to cover the 625 MHz-762.5 MHz, the 1087.5 MHz-1525 MHz, the 2175 MHz-3050 MHz and the 4350 MHz-5000 MHz bands.

The STW81103 is designed with STMicroelectronics advanced 0.35 µm SiGe process.

Contents STW81103

# **Contents**

1	Bloc	k diagram and pin configuration
	1.1	Block diagram
	1.2	Pin configuration
2	Elect	trical specifications9
	2.1	Absolute maximum ratings
	2.2	Operating conditions 9
	2.3	Digital logic levels
	2.4	Electrical specifications 10
	2.5	Phase noise specification
3	Туріс	cal performance characteristics15
4	Gene	eral description
5	Circu	uit description
	5.1	Reference input stage
	5.2	Reference divider
	5.3	Prescaler 19
	5.4	A and B counters
	5.5	Phase frequency detector (PFD)
	5.6	Lock detect
	5.7	Charge pump
	5.8	Voltage controlled oscillators
		5.8.1 VCO selection
		5.8.2 VCO frequency calibration
		5.8.3 VCO voltage amplitude control
	5.9	Output stage
		5.9.1 Output buffer control mode
	5.10	External VCO buffer
6	I <sup>2</sup> C b	us interface
	6.1	General features

STW81103 Contents

		6.1.1	Data validity
		6.1.2	START and STOP conditions
		6.1.3	Byte format and acknowledge28
		6.1.4	Device addressing
		6.1.5	Single-byte write mode29
		6.1.6	Multi-byte write mode
		6.1.7	Current byte address read mode
	6.2	Timing	specification 30
	6.3	I <sup>2</sup> C reg	gisters 32
		6.3.1	Write-only registers
		6.3.2	Read-only register 34
		6.3.3	Default configuration34
	6.4	VCO c	alibration procedure
		6.4.1	VCO calibration auto-restart feature
7	SPI	digital ir	nterface
	7.1	Genera	al features
	7.2	Timing	specification
	7.3	Bit tabl	es
		7.3.1	Default configuration
	7.4	VCO c	alibration procedure
		7.4.1	VCO calibration auto-restart feature
8	Арр	lication	information 41
	8.1		output
	8.2		d by 2 output
	8.3		d by 4 output
	8.4		tion kit
9	Арр	lication	diagram
10	Pack	kage me	chanical data
11	Orde	ering inf	ormation 52
12	Revi	sion his	story 52

List of tables STW81103

# List of tables

l able 1.	Pin description	/
Table 2.	Absolute maximum ratings	9
Table 3.	Operating conditions	9
Table 4.	Digital logic levels	. 10
Table 5.	Electrical specifications	. 10
Table 6.	Phase noise specification · · · · · · · · · · · · · · · · · · ·	13
Table 7.	Current value vs. selection	. 22
Table 8.	VCO A performances versus amplitude setting (Freq = 2.8 GHz)	. 24
Table 9.	VCO B performances vs. amplitude setting (Freq = 4.7 GHz)	. 25
Table 10.	EXT_PD pin function setting	. 25
Table 11.	Single-byte write mode	. 29
Table 12.	Multi-byte write mode	. 29
Table 13.	Current byte address read mode	. 29
Table 14.	Data and clock timing specifications	. 30
Table 15.	Start and stop timing specifications	. 31
Table 16.	Ack timing specifications	. 31
Table 17.	Write-only registers	. 32
Table 18.	Functional modes	. 32
Table 19.	SPI data structure (MSB is sent first)	. 37
Table 20.	Address decoder and outputs	. 37
Table 21.	SPI timing specification	. 37
Table 22.	Bits at 00h and ST1	. 38
Table 23.	Bits at 01h and ST2	. 39
Table 24.	Order code of the evaluation kit	. 46
Table 25.	Package dimensions	. 51
Table 26.	Order codes	. 52
Tahla 27	Document revision history	52

STW81103 List of figures

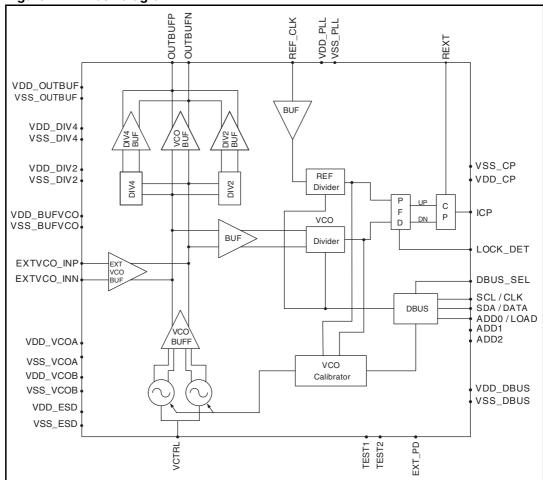
# **List of figures**

Figure 1.	Block diagram	. 6
Figure 2.	Pin connection (top view)	. 7
Figure 3.	VCO A (direct output) open loop phase noise	. 15
Figure 4.	VCO B (direct output) open loop phase noise	15
Figure 5.	VCO A (direct output) closed loop phase noise at 2.775 GHz	
(FSTEP=200	0 kHz; FPFD=200 kHz; ICP=2 mA)	. 15
Figure 6.	VCO B (direct output) closed loop phase noise at 4.675 GHz	
(FSTEP=200	0 kHz; FPFD=200 kHz; ICP=3 mA)	. 15
Figure 7.	VCO A (div. by 2 output) closed loop phase noise at 1.3876 GHz	
(FSTEP=200	0 kHz; FPFD=400 kHz; ICP=1.5 mA)	16
Figure 8.	VCO B (div. by 2 output) closed loop phase noise at 2.3376 GHz	
(FSTEP=200	0 kHz; FPFD=400 kHz; ICP=2 mA)	16
Figure 9.	VCO A (div. by 4 output) closed loop phase noise at 693.8 MHz	
(FSTEP=200	0 kHz; FPFD=800 kHz; ICP=1 mA)	16
Figure 10.	VCO B (div. by 4 output) closed loop phase noise at 1168.8 MHz	
(FSTEP=200	0 kHz; FPFD=800 kHz; ICP=1.5 mA)	16
Figure 11.	PFD frequency spurs (direct output; FPFD=200 kHz)	
Figure 12.	PFD frequency spurs (div. by 2 output; FPFD=400 kHz)	
Figure 13.	PFD frequency spurs (div. by 4 output; FPFD=800 kHz)	
Figure 14.	Settling time (final frequency=2.4 GHz; FPFD=400 kHz; ICP=2.5 mA)	
Figure 15.	Reference frequency input buffer	
Figure 16.	VCO divider diagram	
Figure 17.	PFD diagram	
Figure 18.	Loop filter connection	
Figure 19.	VCO sub-bands frequency characteristics	
Figure 20.	Data validity	
Figure 21.	START and STOP conditions	
Figure 22.	Byte format and acknowledge	
Figure 23.	Data and clock	
Figure 24.	Start and stop	
Figure 25.	Ack	
Figure 26.	SPI input and output bit order	
Figure 27.	SPI timing specification.	
Figure 28.	Differential/single-ended output network (MATCH_LC_LUMP_4G_DIFF.dsn)	
Figure 29.	LC lumped balun and matching network (MATCH_LC_LUMP_4G.dsn)	
Figure 30.	Evaluation board (EVB4G) matching network (MATCH_EVB4G.dsn)	
Figure 31.	Differential/single-ended output network (MATCH_LC_LUMP_2G_DIFF.dsn)	
Figure 32.	LC lumped balun for divided by 2 output (MATCH_LC_LUMP_2G.dsn)	
Figure 33.	Evaluation board (EVB2G) matching network (MATCH_EVB2G.dsn)	
Figure 34.	LC lumped balun for divided by 4 output (MATCH_LC_LUMP_1G.dsn)	
Figure 34. Figure 35.	Evaluation board (EVB1G) matching network (MATCH_EVB1G.dsn)	
Figure 35. Figure 36.	· · · · · · · · · · · · · · · · · · ·	
•	Typical application diagram	
Figure 37.	Ping-pong architecture diagram	
Figure 38.	Application diagram with external VCO (LO output from STW81103)	
Figure 39.	Application diagram with external VCO (LO output from VCO)	
Figure 40.	VFQFPN28 mechanical drawing	. 50

# 1 Block diagram and pin configuration

### 1.1 Block diagram

Figure 1. Block diagram



#### 1.2 Pin configuration

Figure 2. Pin connection (top view)

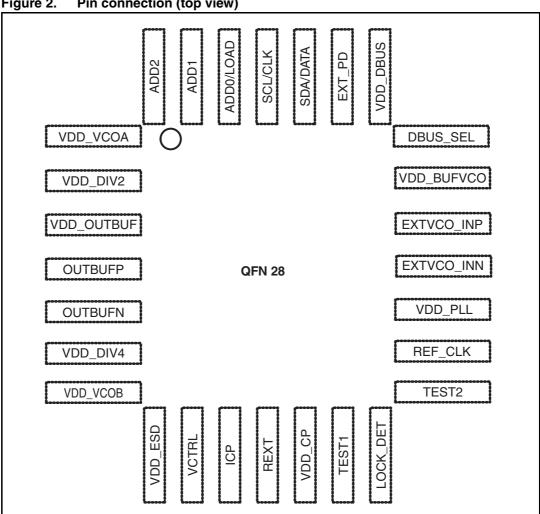


Table 1. Pin description

Pin No	Name	Description	Observation
1	VDD_VCOA	VCO A power supply	
2	VDD_DIV2	Divider by 2 power supply	
3	VDD_OUTBUF	Output buffer power supply	
4	OUTBUFP	LO buffer positive output	Open collector
5	OUTBUFN	LO buffer negative output	Open collector
6	VDD_DIV4	Divider by 4 power supply	
7	VDD_VCOB	VCO B power supply	
8	VDD_ESD	ESD positive rail power supply	
9	VCTRL	VCO control voltage	

Table 1. Pin description (continued)

Pin No	Name	Description	Observation
10	ICP	PLL charge pump output	
11	REXT	External resistance connection for PLL charge pump	
12	VDD_CP	Power supply for charge pump	
13	TEST1	Test input 1	For test purposes only; must be connected to GND
14	LOCK_DET	Lock detector	CMOS output (I <sub>OUT</sub> =4mA)
15	TEST2	Test input 2	For test purposes only; must be connected to GND
16	REF_CLK	Reference clock input	
17	VDD_PLL	PLL digital power supply	
18	EXTVCO_INN	External VCO negative input	For test purposes only; must be connected to GND
19	EXTVCO_INP	External VCO positive input	For test purposes only; must be connected to GND
20	VDD_BUFVCO	VCO buffer power supply	
21	DBUS_SEL	Digital Bus Interface select	CMOS input
22	VDD_DBUS	SPI and I <sup>2</sup> C bus power supply	
23	EXT_PD	Power down hardware '0' device ON; '1' device OFF	CMOS input
24	SDA/DATA	I2CBUS/SPI data line	CMOS Bidir Schmitt triggered (I <sub>OUT</sub> =4mA)
25	SCL/CLK	I2CBUS/SPI clock line	CMOS input Schmitt triggered
26	ADD0/LOAD	I2CBUS address select pin/ SPI load line	CMOS input
27	ADD1	I2CBUS address select pin	CMOS input; must be connected to GND in SPI mode
28	ADD2	I2CBUS address select pin	CMOS input; must be connected to GND in SPI mode

# 2 Electrical specifications

## 2.1 Absolute maximum ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Values	Unit
$AV_{CC}$	Analog supply voltage	0 to 4.6	V
DV <sub>CC</sub>	Digital supply voltage	0 to 4.6	V
T <sub>stg</sub>	Storage temperature	+150	°C
ESD	Electrical static discharge - HBM <sup>(1)</sup> - CDM-JEDEC standard - MM	4 1.5 0.2	kV

<sup>1.</sup> The maximum rating of the ESD protection circuitry on pin 4 and pin 5 is 800 V.

## 2.2 Operating conditions

Table 3. Operating conditions (1)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Units
AV <sub>CC</sub>	Analog supply voltage		3.0	3.3	3.6	V
DV <sub>CC</sub>	Digital supply voltage		3.0	3.3	3.6	V
I <sub>VDD1</sub>	V <sub>DD1</sub> current consumption			90		mA
I <sub>VDD2</sub>	V <sub>DD2</sub> current consumption			12		mA
T <sub>amb</sub>	Operating ambient temperature		-40		85	°C
Tj	Maximum junction temperature				125	°C
R <sub>th j-a</sub>	Junction to ambient package thermal resistance	Multilayer JEDEC board		44		°C/W
R <sub>th j-b</sub>	Junction to board package thermal resistance	Multilayer JEDEC board		26.3		°C/W
R <sub>th j-c</sub>	Junction to case package thermal resistance	Multilayer JEDEC board		6.3		°C/W

<sup>1.</sup> Refer to Figure 36: Typical application diagram.

# 2.3 Digital logic levels

Table 4. Digital logic levels

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Units
V <sub>il</sub>	Low-level input voltage				0.2*Vdd	V
V <sub>ih</sub>	High-level input voltage		0.8*Vdd			V
V <sub>hyst</sub>	Schmitt trigger hysteresis		0.8			V
V <sub>ol</sub>	Low-level output voltage				0.4	V
V <sub>oh</sub>	High-level output voltage		0.85*Vdd			V

## 2.4 Electrical specifications

All electrical specifications are intended for a 3.3 V supply voltage.

Table 5. Electrical specifications

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
Output fre	quency range					
		Direct output	2500		3050	MHz
F <sub>OUTA</sub>	Output frequency range with VCOA	Divider by 2	1250		1525	MHz
		Direct output   2500   3050   3050   255   255   2500   255   2500   255   2500   255   2500   255   2500   255   2500   2500   255   2500   255   2500   255   2500   255   2500   255   2550   255	MHz			
		Direct output	4350		5000	MHz
F <sub>OUTB</sub>	Output frequency range with VCOB	Divider by 2	2175		2500	MHz
	VCOB	Divider by 4	1087.5		1250	MHz
VCO divide	ers					
N.	VCO divider ratio	Prescaler 16/17	256		65551	
N		Prescaler 19/20	361		77836	
Reference	clock and phase frequency d	etector				
F <sub>ref</sub>	Reference input frequency		10		200	MHz
	Reference input sensitivity <sup>(1)</sup>		0.35	1	1.5	Vpeak
R	Reference divider ratio		2		1023	
F <sub>PFD</sub>	PFD input frequency				16	MHz
E.	Fraguanay stan <sup>(2)</sup>	Prescaler 16/17			F <sub>OUT</sub> / 256	Hz
F <sub>STEP</sub>	Trieducticy steh.	Prescaler 19/20	F <sub>OUT</sub> / 77836		F <sub>OUT</sub> / 361	Hz

10/53

Table 5. Electrical specifications (continued)

Symbol	Electrical specifications  Parameter	Condition	Min.	Тур.	Max.	Unit
Charge pu	ımp			1		
I <sub>CP</sub>	ICP sink/source <sup>(3)</sup>	3-bit programmable			5	mA
V <sub>OCP</sub>	Output voltage compliance range		0.4		V <sub>dd</sub> -0.3	V
		Direct output (F <sub>PFD</sub> =200 kHz)		-76		dBc
	Spurious <sup>(4)</sup>	Divider by 2 (F <sub>PFD</sub> =400 kHz)		-82		dBc
		Divider by 4 (F <sub>PFD</sub> =800 kHz)		-88		dBc
VCOs						
		Lower frequency range	45	65	85	MHz/V
K <sub>VCOA</sub>	VCOA sensitivity <sup>(5)</sup>	Intermediate frequency range	60	80	105	MHz/V
		Higher frequency range	85	105	145	MHz/V
		Lower frequency range	45	65	85	MHz/V
K <sub>VCOB</sub>	VCOB sensitivity <sup>(5)</sup>	Intermediate frequency range	60	80	100	MHz/V
		Higher frequency range	85	100	130	MHz/V
	Maximum temperature	VCO A	125			°C
$\Delta T_{LK}$	variation for continuous lock <sup>(5) (6)</sup>	VCO B	95			°C
	VCOA pushing <sup>(5)</sup>			4	7	MHz/V
	VCOB pushing <sup>(5)</sup>			15	21	MHz/V
V <sub>CTRL</sub>	VCO control voltage <sup>(5)</sup>		0.4		3	V
	LO harmonic spurious <sup>(5)</sup>				-20	dBc
l	VCOA current consumption	F <sub>VCO</sub> =2.8 GHz; amplitude[11]		30		mA
I <sub>VCOA</sub>	VCOA current consumption	F <sub>VCO</sub> =2.8 GHz; amplitude[00]		16		mA
lugge	VCOB current consumption	F <sub>VCO</sub> =4.7 GHz; amplitude[11]		24		mA
I <sub>VCOB</sub>	VOOD current consumption	F <sub>VCO</sub> =4.7 GHz; amplitude[00]		13		mA
I <sub>VCOBUF</sub>	VCO buffer consumption			15		mA
$I_{DIV2}$	Divider by 2 consumption			17		mA
I <sub>DIV4</sub>	Divider by 4 consumption			14		mA
LO output	buffer					
$P_{LO}$	Output level			0		dBm
$R_{L}$	Return loss	Matched to 50 ohms		15		dB
		DIV4 Buff		26		mA
I <sub>OUTBUF</sub>	Current consumption	DIV2 Buff		23		mA
		Direct output		39		mA

Table 5. **Electrical specifications (continued)** 

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit		
External VCO								
	Frequency range		0.625		5.0	GHz		
	Input level		-10		+6	dBm		
	Current consumption	VCO internal buffer		28		mA		
PLL misce	PLL miscellaneous							
I <sub>PLL</sub>	Current consumption	Input buffer, prescaler, digital dividers, misc.		12		mA		
t <sub>lock</sub>	Lockup time <sup>(5) (7)</sup>	25 kHzPLLbandwidth; within 1 ppm of frequency error		150		μs		

- 1. In order to achieve best phase noise performance 1 V peak level is suggested.
- 2. The frequency step is related to the PFD input frequency as follows:

  - F<sub>step</sub> = F<sub>PFD</sub> for direct output F<sub>step</sub> = F<sub>PFD</sub>/2 for divided by 2 output F<sub>step</sub> = F<sub>PFD</sub>/4 for divided by 4 output
- 3. See relationship between ICP and REXT in Section 5.7: Charge pump.
- 4. The level of the spurs may change depending on PFD frequency, charge pump current, selected channel and PLL loop
- 5. Guaranteed by design and specification.
- When setting a specified output frequency, the VCO calibration procedure must be run in order to select the best sub-range when setting a specified output frequency, the VCO calibration procedure fruits be full in order to select the best sub-range for the VCO covering the desired frequency. Once programmed at the initial temperature  $T_0$  inside the operating temperature range (-40 °C to +85 °C), the synthesizer is able to maintain the lock status only if the temperature drift (in either direction) is within the limit specified by  $\Delta T_{LK}$ , provided that the final temperature  $T_1$  is still inside the nominal range. If higher  $\Delta T$  are required the "VCO calibration auto-restart" feature can be enabled, thus allowing to re-start the VCO calibration procedure automatically when the part loose the lock condition (trigger on lock detector signal).
- 7. Frequency jump from 2250 to 2400 MHz; it includes the time required by the VCO calibration procedure (7  $F_{PFD}$  cycles with  $F_{PFD}$ =400 kHz).

# 2.5 Phase noise specification

Table 6. Phase noise specification <sup>(1)</sup>

Parameter	Test conditions	Min.	Тур.	Max.	Unit
In-band phase noise floor - clo	sed loop <sup>(2)</sup>				
Normalized inband phase noise floor			-222		dBc/Hz
Inband phase noise floor direct output	ICP=4 mA, PLL BW=50 kHz;	-222+20	Dlog(N)+10lo	g(F <sub>PFD</sub> )	dBc/Hz
Inband phase noise floor divider by 2	including reference clock contribution	-228+20	Dlog(N)+10lo	g(F <sub>PFD</sub> )	dBc/Hz
Inband phase noise floor divider by 4		-234+20	Dlog(N)+10lo	g(F <sub>PFD</sub> )	dBc/Hz
PLL integrated phase noise – d	irect output				
Integrated phase noise	F <sub>OUT</sub> =4.675 GHz, F <sub>PFD</sub> =200 kHz, F <sub>STEP</sub> =200 kHz,		-34.6		dBc
100 Hz to 40 MHz	PLL BW = 15 kHz, ICP=3 mA		1.5		° rms
PLL integrated phase noise – d	ivider by 2				
Integrated phase noise	F <sub>OUT</sub> =2.3376 GHz, F <sub>PFD</sub> =400 kHz, F <sub>STEP</sub> =200 kHz,		-42.6		dBc
100 Hz to 40 MHz	PLL BW=25 kHz, ICP=2 mA		0.6		° rms
PLL integrated phase noise – d	ivider by 4	I.	·		I.
Integrated phase noise	F <sub>OUT</sub> =1.1688 GHz, F <sub>PFD</sub> =800 kHz, F <sub>STEP</sub> =200 kHz,		-49.5		dBc
100 Hz to 40 MHz	PLL BW=35 kHz, ICP=1.5 mA		0.27		° rms
VCO A direct (2500 MHz-3050 N	IHz) – open loop <sup>(3)</sup>	I	L		I
Phase noise @ 1 kHz			-59		dBc/Hz
Phase noise @ 10 kHz			-87		dBc/Hz
Phase noise @ 100 kHz			-109		dBc/Hz
Phase noise @ 1 MHz			-131		dBc/Hz
Phase noise @ 10 MHz			-151		dBc/Hz
Phase noise @ 40 MHz			-161		dBc/Hz
VCO B direct (4350 MHz-5000 M	IHz) – open loop <sup>(3)</sup>	l .	·		l .
Phase noise @ 1 kHz			-54		dBc/Hz
Phase noise @ 10 kHz			-82		dBc/Hz
Phase noise @ 100 kHz			-105		dBc/Hz
Phase noise @ 1 MHz			-127		dBc/Hz
Phase noise @ 10 MHz			-147		dBc/Hz
Phase noise @ 40 MHz			-157		dBc/Hz

Table 6. Phase noise specification (1) (continued)

Parameter	Test conditions	Min.	Тур.	Max.	Unit
VCO A with divider by 2 (1250 MHz-	1525 MHz) – open loop <sup>(3)</sup>	<u> </u>		·	
Phase noise @ 1 kHz			-65		dBc/Hz
Phase noise @ 10 kHz			-93		dBc/Hz
Phase noise @ 100 kHz			-115		dBc/Hz
Phase noise @ 1 MHz			-137		dBc/Hz
Phase noise @ 10 MHz			-153		dBc/Hz
Phase noise floor @ 40 MHz			-155		dBc/Hz
VCO B with divider by 2 (2175 MHz-	2500 MHz) – open loop <sup>(3)</sup>	'			
Phase noise @ 1 kHz			-60		dBc/Hz
Phase noise @ 10 kHz			-88		dBc/Hz
Phase noise @ 100 kHz			-111		dBc/Hz
Phase noise @ 1 MHz			-132		dBc/Hz
Phase noise @ 10 MHz			-150		dBc/Hz
Phase noise floor @ 40 MHz			-154		dBc/Hz
VCO A with divider by 4 (625 MHz-7	62.5 MHz) – open loop <sup>(3)</sup>	1			
Phase noise @ 1 kHz			-71		dBc/Hz
Phase noise @ 10 kHz			-99		dBc/Hz
Phase noise @ 100 kHz			-121		dBc/Hz
Phase noise @ 1 MHz			-142		dBc/Hz
Phase noise @ 10 MHz			-154		dBc/Hz
Phase noise floor @ 40 MHz			-155		dBc/Hz
VCO B with divider by 4 (1087.5 MH	z-1250 MHz) – open loop <sup>(3)</sup>	'			
Phase noise @ 1 kHz			-66		dBc/Hz
Phase noise @ 10 kHz			-94		dBc/Hz
Phase noise @ 100 kHz			-117		dBc/Hz
Phase noise @ 1 MHz			-138		dBc/Hz
Phase noise @ 10 MHz			-153		dBc/Hz
Phase noise floor @ 40 MHz			-154		dBc/Hz

<sup>1.</sup> Phase Noise SSB. VCO amplitude setting to value [11]. All closed-loop performances are specified using a reference clock signal at 76.8 MHz with a phase noise of -135 dBc/Hz @1 kHz offset, -145dBc/Hz @10kHz offset and -149.5 dBc/Hz of noise floor.

An evaluation kit is available upon request, including a powerful simulation tool (STWPLLSim) that allows a very accurate estimation of the device's phase noise according to the desired project parameters (VCO frequency, selected output stage, reference clock, frequency step, and so on); refer to *Section 8: Application information* for more details.

<sup>2.</sup> Normalized PN = Measured PN -  $20\log(N) - 10\log(F_{PFD})$ , where N is the VCO divider ratio (N=B\*P+A) and  $F_{PFD}$  is the comparison frequency at the PFD input.

<sup>3.</sup> Typical phase noise at centre band frequency.

## 3 Typical performance characteristics

Phase noise is measured with the Agilent E5052A Signal Source Analyzer. All closed-loop measurements are done with  $F_{STEP}$ =200 kHz, with the  $F_{PFD}$  and charge pump current properly set. The loop filter configuration is depicted in *Figure 36: Typical application diagram*, and the reference clock signal is at 76.8 MHz with a phase noise of -135 dBc/Hz @1 kHz offset, -145 dBc/Hz @10 kHz offset and -149.5 dBc/Hz of noise floor.

Figure 3. VCO A (direct output) open loop phase noise

Figure 4. VCO B (direct output) open loop phase noise

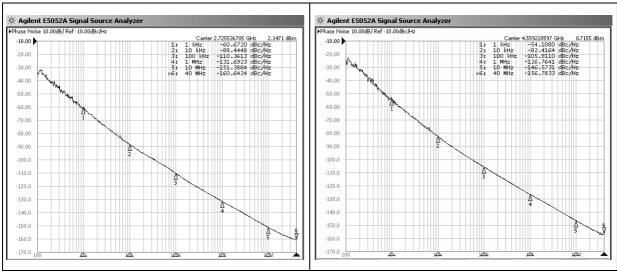
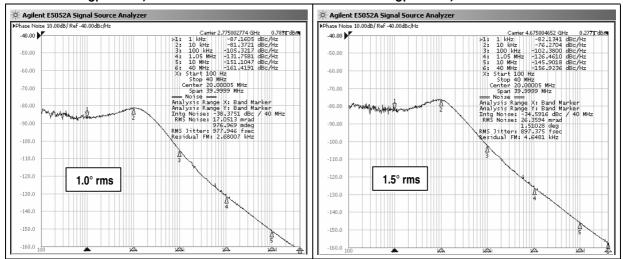


Figure 5. VCO A (direct output) closed loop phase noise at 2.775 GHz (F<sub>STEP</sub>=200 kHz; F<sub>PFD</sub>=200 kHz; I<sub>CP</sub>=2 mA)

Figure 6. VCO B (direct output) closed loop phase noise at 4.675 GHz (F<sub>STEP</sub>=200 kHz; F<sub>PFD</sub>=200 kHz; I<sub>CP</sub>=3 mA)



47/

Figure 7. VCO A (div. by 2 output) closed loop phase noise at 1.3876 GHz (F<sub>STEP</sub>=200 kHz; F<sub>PFD</sub>=400 kHz; I<sub>CP</sub>=1.5 mA)

Figure 8. VCO B (div. by 2 output) closed loop phase noise at 2.3376 GHz (F<sub>STEP</sub>=200 kHz; F<sub>PFD</sub>=400 kHz; I<sub>CP</sub>=2 mA)

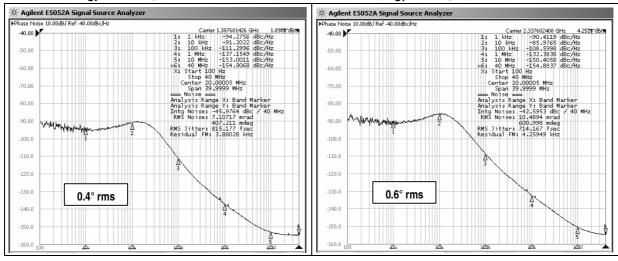


Figure 9. VCO A (div. by 4 output) closed loop phase noise at 693.8 MHz ( $F_{STEP}$ =200 kHz;  $F_{PFD}$ =800 kHz;  $I_{CP}$ =1 mA)

Figure 10. VCO B (div. by 4 output) closed loop phase noise at 1168.8 MHz (F<sub>STEP</sub>=200 kHz; F<sub>PFD</sub>=800 kHz; I<sub>CP</sub>=1.5 mA)

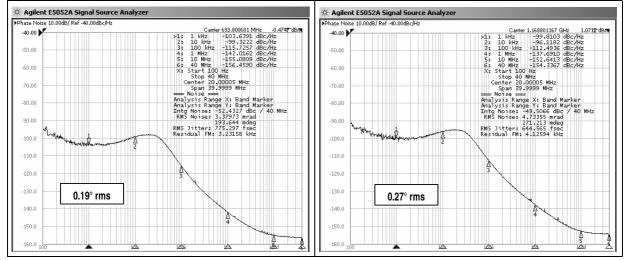
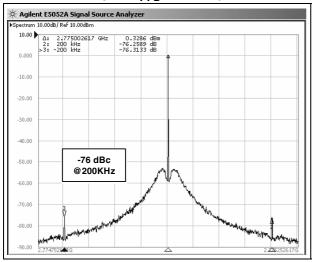


Figure 11. PFD frequency spurs (direct output; F<sub>PFD</sub>=200 kHz)

Figure 12. PFD frequency spurs (div. by 2 output; F<sub>PFD</sub>=400 kHz)



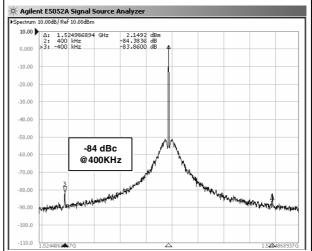
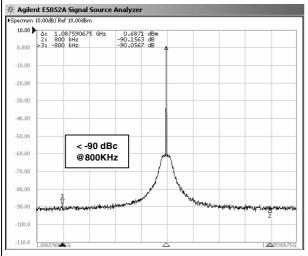
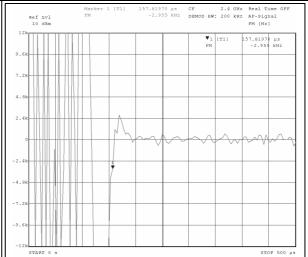


Figure 13. PFD frequency spurs (div. by 4 output; F<sub>PFD</sub>=800 kHz)

Figure 14. Settling time (final frequency=2.4 GHz; F<sub>PFD</sub>=400 kHz; I<sub>CP</sub>=2.5 mA)





General description STW81103

## 4 General description

*Figure 1: Block diagram* shows the separate blocks that, when integrated, form an Integer-N PLL frequency synthesizer.

The STW81103 consists of two internal low-noise VCOs with buffer blocks, a divider by 2, a divider by 4, a low-noise PFD (phase frequency detector), a precise charge pump, a 10-bit programmable reference divider, two programmable counters and a programmable dual-modulus prescaler. The 5-bit A-counter and 12-bit B-counter, in conjunction with the dual-modulus prescaler P/P+1 (16/17 or 19/20), implement an N integer divider, where  $N = B^*P + A$ . The division ratio of both reference and VCO dividers is controlled through the selected digital interface ( $I^2C$  bus or SPI).

The digital interface type is selected through the proper hardware connection of pin DBUS\_SEL (0 V for I<sup>2</sup>C bus, 3.3 V for SPI).

All devices operate with a power supply of 3.3 V, and can be powered down when not in use.

STW81103 **Circuit description** 

#### **Circuit description** 5

#### Reference input stage 5.1

The reference input stage is shown in Figure 15. The resistor network feeds a DC bias at the F<sub>ref</sub> input, while the inverter used as the frequency reference buffer is AC coupled.

Figure 15. **VDD** Fref INV **BUF** Power Down

Reference frequency input buffer

#### 5.2 Reference divider

The 10-bit programmable reference counter allows division of the input reference frequency to produce the input clock to the PFD. The division ratio is programmed through the digital interface.

#### 5.3 **Prescaler**

The dual-modulus prescaler P/P+1 takes the CML clock from the VCO buffer and divides it down to a manageable frequency for the CMOS A and B counters. The modulus P is programmable and can be set to 16 or 19. The prescaler is based on a synchronous 4/5 core whose division ratio depends on the state of the modulus input.

57 19/53 Circuit description STW81103

### 5.4 A and B counters

The 5-bit A-counter and 12-bit B-counter, in conjunction with the selected dual modulus (16/17 or 19/20) prescaler, allow the generation of output frequencies that are spaced only by the reference frequency divided by the reference division ratio. The division ratio and the VCO output frequency are given by the following formulas:

 $N = B \times P + A$ 

$$F_{VCO} = \frac{(B \times P + A)}{B} \times F_{ref}$$

where

F<sub>VCO</sub>: output frequency of VCO

P: modulus of dual modulus prescaler (16 or 19 selected through the digital interface)

B: division ratio of the main counter

A: division ratio of the swallow counter

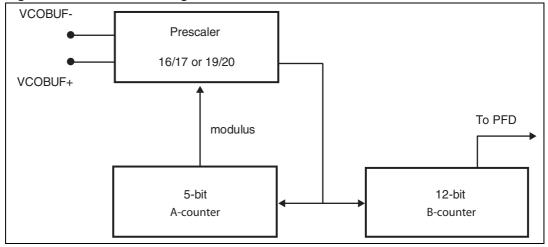
F<sub>ref</sub>: input reference frequency

R: division ratio of the reference counter

N: division ratio of the PLL

For the VCO divider to work correctly, B absolutely must be greater than A, which can take any value ranging from 0 to 31. The value range of N is either from 256 to 65551 (if P=16) or from 361 to 77836 (P=19).

Figure 16. VCO divider diagram



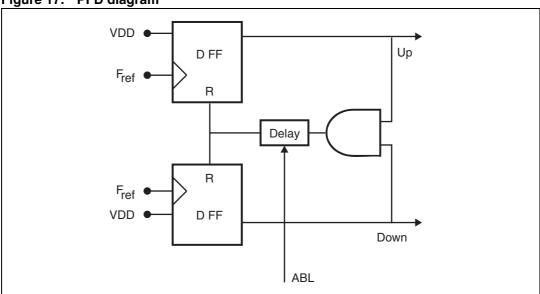
STW81103 Circuit description

### 5.5 Phase frequency detector (PFD)

The PFD takes inputs from the reference and the VCO dividers and produces an output proportional to the phase error. The PFD includes a delay gate that controls the width of the anti-backlash pulse. This pulse ensures that there is no dead zone in the PFD transfer function.

Figure 17 is a simplified schematic of the PFD.

Figure 17. PFD diagram



### 5.6 Lock detect

This signal indicates that the difference between rising edges of both UP and DOWN PFD signals is found to be shorter than the fixed delay (roughly 5 ns). The Lock Detect signal is high when the PLL is locked and low when the PLL is unlocked. Lock Detect consumes current only during PLL transients.

## 5.7 Charge pump

This block drives two matched current sources,  $I_{UP}$  and  $I_{DOWN}$ , which are controlled respectively by UP and DOWN PFD outputs. The nominal value of the output current is controlled by an external resistor (connected to the REXT input pin) and a 3-bit word that allows selection among 8 different values.

The minimum value of the output current is:  $I_{MIN} = 2*VBG/REXT$  (VBG~1.17 V)

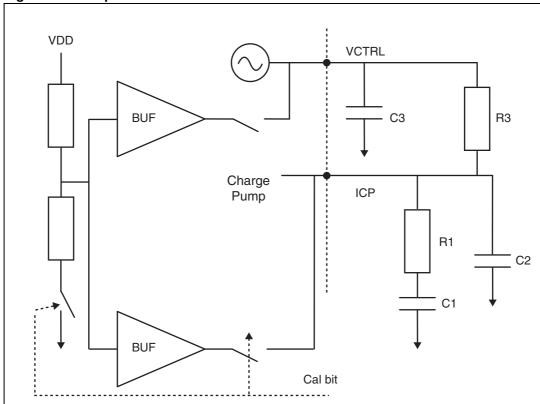
Circuit description STW81103

Table 7. Current value vs. selection

CPSEL2	CPSEL1	CPSEL0	Current	Value for REXT=4.7 KΩ
0	0	0	I <sub>MIN</sub>	0.5 mA
0	0	1	2*I <sub>MIN</sub>	1.0 mA
0	1	0	3*I <sub>MIN</sub>	1.5 mA
0	1	1	4*I <sub>MIN</sub>	2.0 mA
1	0	0	5*I <sub>MIN</sub>	2.5 mA
1	0	1	6*I <sub>MIN</sub>	3.0 mA
1	1	0	7*I <sub>MIN</sub>	3.5 mA
1	1	1	8*I <sub>MIN</sub>	4.0 mA

Note: The current is output on pin ICP. During VCO auto-calibration, the ICP and VCTRL pins are forced to VDD/2.

Figure 18. Loop filter connection



STW81103 Circuit description

### 5.8 Voltage controlled oscillators

### 5.8.1 VCO selection

The STW81103 integrates two low-noise VCOs to cover a wide band from:

- 2500 MHz to 3050 MHz and from 4350 MHz to 5000 MHz (direct output)
- 1250 MHz to 1525 MHz and from 2175 MHz to 2500 MHz (selecting divider by 2)
- 625 MHz to 762.5 MHz and from 1087.5 MHz to 1250 MHz (selecting divider by 4)

The frequency range is 2500 MHz-3050 MHz for VCO A, and 4350 MHz-5000 MHz for VCO B

### 5.8.2 VCO frequency calibration

Both VCOs can operate on 32 frequency ranges that are selected by adding or subtracting capacitors from the resonator. These frequency ranges are intended to cover the wide band of operation and compensate for process variation on the VCO center frequency.

The range is automatically selected when the SERCAL bit is set to 1. The charge pump is inhibited, and the ICP and VCTRL pins are at VDD/2 volts. The ranges are then tested with this VCO input voltage to select the one nearest to the desired output frequency  $(F_{OLIT} = N^*F_{ref}/R)$ .

After this selection, the SERCAL bit is automatically reset to 0 and the charge pump is once again enabled. To enable a fast settle, the PLL needs only to perform fine adjustments around VDD/2 on the loop filter to reach  $F_{OLT}$ .

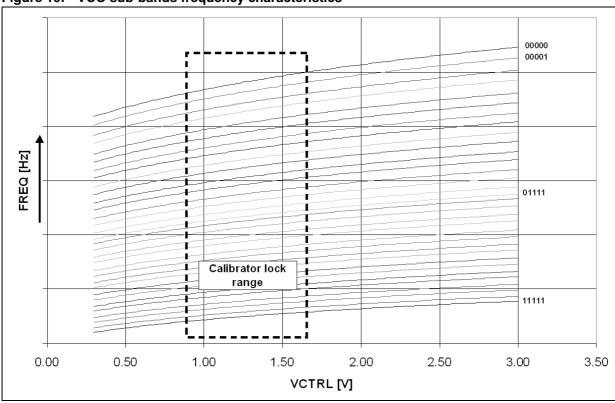


Figure 19. VCO sub-bands frequency characteristics

Circuit description STW81103

The SERCAL bit should be set to "1" at each division ratio change. The VCO calibration procedure takes approximately 7 periods of the PFD frequency.

The maximum allowed  $F_{PFD}$  to perform the calibration process is 1 MHz. When using a higher  $F_{PFD}$ , follow the steps below:

- Calibrate the VCO at the desired frequency with an F<sub>PFD</sub> less than 1 MHz.
- Set the ratio of the A, B and R dividers for the desired F<sub>PFD</sub>.

#### VCO calibration auto-restart feature

The VCO calibration auto-restart feature, once activated, allows to restart the calibration procedure when the lock detector reports that the PLL has moved to an unlock condition (trigger on '1' to '0' transition of lock detector signal).

This situation could happen if the device experiences a significant temperature variation. Once programmed at the initial temperature  $T_0$  inside the operating temperature range (-40 °C to +85 °C), the synthesizer is able to maintain the lock status only if the temperature drift (in either direction) is within the limit specified by the  $\Delta T_{LK}$  parameter, provided that the final temperature  $T_1$  is still inside the nominal range.

Each VCO featured by STW81103 has its specific  $\Delta T_{LK}$  parameter reported in *Table 5*, that is typically lower than the maximum allowable drift ( $\Delta T_{MAX}$ =125; from -40 °C to +85 °C and vice versa).

By enabling the VCO calibration auto-restart feature (through the CAL\_AUTOSTART\_EN bit), the part will be able to select again the proper VCO frequency sub-range if the temperature drift exceeds the  $\Delta T_{LK}$  limit, without any external user command.

### 5.8.3 VCO voltage amplitude control

The voltage swing of the VCOs can be adjusted over four levels by means of two dedicated programming bits (PLL\_A1 and PLL\_A0). Higher amplitudes provide best phase noise, whereas lower amplitudes save power.

*Table 8* gives the voltage swing level expected on the resonator nodes, the current consumption, and the phase noise at 1 MHz.

Table 8.	VCO A performances	versus amplitude setting	j (Freq = 2.8 GHz)
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PLL_A[1:0]	Differential voltage swing (Vp)	Current consumption (mA)	PN @1 MHz (dBc/Hz)
00	1.1	16	-126
01	1.3	19	-127
10	1.9	27	-130
11	2.1	30	-131

STW81103 Circuit description

**Differential** Current PN at 1 MHz PLL\_A[1:0] voltage swing (Vp) consumption (mA) (dBc/Hz) -121 00 1.1 13 1.3 -122 01 15 10 1.9 22 -126 2.1 -127 11 24

Table 9. VCO B performances vs. amplitude setting (Freq = 4.7 GHz)

### 5.9 Output stage

The differential output signal of the synthesizer can be selected by software among three different signal paths (direct, divider by 2 and divider by 4) providing multi-band capability.

The selection of the output stage is done by programming properly the PD[4:0] bits.

The output stage is an open-collector structure which is able to meet different requirements over the desired output frequency range by proper connections on the PCB. Refer to *Section 8: Application information* for more details on PCB connections.

### 5.9.1 Output buffer control mode

This control mode allows to enable/disable the output stage by a hardware control pin (EXT\_PD, pin#23) while the PLL stays locked at the desired frequency; in such a way a very fast switching time is achieved.

This feature can be useful in designing a ping-pong architecture saving the cost of an external RF switch.

The function of pin#23 (EXT\_PD) is set with the OUTBUF\_CTRL\_EN bit as shown in *Table 10.* 

Table 10. EXT\_PD pin function setting

OUTBUF_CTRL_EN	Function of the EXT_PD pin	EXT_PD pin settings
0	Device hardware power down	EXT_PD = 0 V → Device ON
	Device nardware power down	EXT_PD = 3.3 V → Device OFF
1	Output Buffer control	EXT_PD = 0 V → Output Stage ON
	Output buller collition	EXT_PD = 3.3 V → Output Stage OFF

25/53

Circuit description STW81103

### 5.10 External VCO buffer

Although the main benefits of the STW81103 are the two wideband and low-noise VCOs, the capability to use an external VCO is also provided.

The external VCO buffer is able to manage a signal coming from an external VCO in order to build a synthesizer using the STW81103 only as PLL IC. The output signal of the synthesizer can also be taken from the output section of the STW81103 (direct, divided by 2 or divided by 4 by) by properly setting the PD[4:0] bits, thus providing additional flexibility.

The external VCO signal can range from 625 MHz up to 5 GHz and its minimum power level must be -10 dBm.

STW81103 I<sup>2</sup>C bus interface

## 6 I<sup>2</sup>C bus interface

The I<sup>2</sup>C bus interface is selected by hardware connection of pin #21 (DBUS\_SEL) to 0 V.

Data is transmitted from microprocessor to the STW81103 through the 2-wire (SDA and SCL) I<sup>2</sup>C bus interface. The STW81103 is always a slave device.

The I<sup>2</sup>C bus protocol defines any device that sends data on the bus as a transmitter, and any device that reads the data as a receiver. The device controlling the data transfer is the master, and the others are slaves. The master always initiates the transfer and provides the serial clock for synchronization.

The STW81103 I<sup>2</sup>C bus supports Fast Mode operation (clock frequency up to 1MHz).

### 6.1 General features

### 6.1.1 Data validity

Data changes on the SDA line must only occur when the SCL is low. SDA transitions while the clock is high are used to identify a START or STOP condition.

SCL

Data line
Stable data
Valid

Change
data
data
allowed

Figure 20. Data validity

### 6.1.2 START and STOP conditions

### **START** condition

A START condition is identified by a transition of the data bus SDA from high to low while the clock signal SCL is stable in the high state. A START condition must precede any data transfer command.

#### **STOP** condition

A STOP condition is identified by a transition of the data bus SDA from low to high while the clock signal SCL is stable in the high state. A STOP condition terminates communications between the STW81103 and the bus master.

I<sup>2</sup>C bus interface STW81103

SCL SDA **START STOP** 

Figure 21. START and STOP conditions

#### 6.1.3 Byte format and acknowledge

Every byte put on the SDA line must be 8 bits long, starting with the most significant bit (MSB), and be followed by an acknowledge bit to indicate a successful data transfer.

The transmitter releases the SDA line after sending 8 bits of data. During the 9th clock pulse, the receiver pulls the SDA line low to acknowledge the receipt of 8 bits of data.

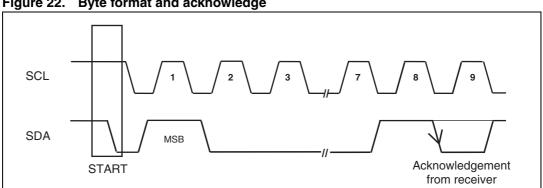


Figure 22. Byte format and acknowledge

#### **Device addressing** 6.1.4

The master must first initiate with a START condition to communicate with the STW81103, and then send 8 bits (MSB first) on the SDA line which correspond to the device select address and the read or write mode.

The first seven MSBs are the device address identifier, which corresponds to the I<sup>2</sup>C bus definition. For the STW81103, the address is set at " $1100A_2A_1A_0$ ", 3 bits programmable. The 8th bit (LSB) is the read or write (RW) operation bit, which is set to 1 in read mode and to 0 in write mode.

Following a START condition, the STW81103 identifies the device address on the bus and, if matched, acknowledges the identification on the SDA bus during the 9th clock pulse.

STW81103 I<sup>2</sup>C bus interface

### 6.1.5 Single-byte write mode

Following a START condition, the master sends a device select code with the RW bit set to 0. The STW81103 sends an acknowledge and waits for the 1-byte internal sub-address that provides access to the internal registers.

After receiving the sub-address internal byte, the STW81103 again responds with an acknowledge. A single-byte write to sub-address 00H changes the FUNCTIONAL\_MODE register, a single-byte write with sub-address 04H changes the CONTROL register, and so on.

#### Table 11. Single-byte write mode

S	1100A <sub>2</sub> A <sub>1</sub> A <sub>0</sub>	0	ack	sub-address byte	ack	DATA IN	ack	Р	1
---	--	---	-----	------------------	-----	---------	-----	---	---

### 6.1.6 Multi-byte write mode

The multi-byte write mode can start from any internal address. The master sends the data bytes, and each one is acknowledged. The master terminates the transfer by generating a STOP condition.

The sub-address decides the starting byte. For example, a multi-byte with sub-address 01H and 2 DATA\_IN bytes changes the B\_COUNTER and A\_COUNTER registers (01H,02H), and a multi-byte with sub-address 00H and 6 DATA\_IN bytes changes all the STW81103 registers.

### Table 12. Multi-byte write mode

S	1100A <sub>2</sub> A <sub>1</sub> A <sub>0</sub>	0	ack	sub-address byte	ack	DATA IN	ack		DATA IN	ack	Р	
---	--	---	-----	------------------	-----	---------	-----	--	---------	-----	---	--

### 6.1.7 Current byte address read mode

In the current byte address read mode, following a START condition, the master sends the device address with the RW bit set to 1. Note that no sub-address is needed since there is only one read register. The STW81103 acknowledges this and outputs the data byte. The master does not acknowledge the received byte, and terminates the transfer with a STOP condition.

#### Table 13. Current byte address read mode

S	1100A <sub>2</sub> A <sub>1</sub> A <sub>0</sub>	1	ack	DATA OUT	No ack	Р
---	--	---	-----	----------	--------	---

29/53

I<sup>2</sup>C bus interface STW81103

# 6.2 Timing specification

Figure 23. Data and clock

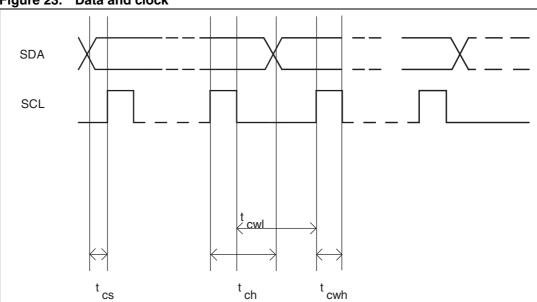
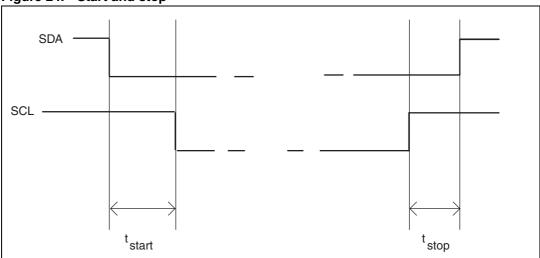


Table 14. Data and clock timing specifications

Symbol	Parameter	Minimum time	Units
t <sub>cs</sub>	Data to clock setup time	2	ns
t <sub>ch</sub>	Data to clock hold time	2	ns
t <sub>cwh</sub>	Clock pulse width high	10	ns
t <sub>cwl</sub>	Clock pulse width low	5	ns

Figure 24. Start and stop



STW81103 I<sup>2</sup>C bus interface

Table 15. Start and stop timing specifications

Symbol	Parameter	Minimum time	Units
t <sub>start</sub>	Clock to data start time	2	ns
t <sub>stop</sub>	Data to clock down stop time	2	ns

Figure 25. Ack

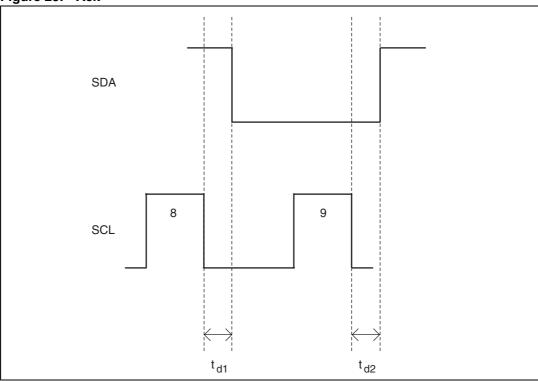


Table 16. Ack timing specifications

Symbol	Parameter	Minimum time	Units
t <sub>d1</sub>	Ack begin delay	2	ns
t <sub>d2</sub>	Ack end delay	2	ns

I<sup>2</sup>C bus interface STW81103

# 6.3 I<sup>2</sup>C registers

The STW81103 has 6 write-only registers and 1 read-only register.

### 6.3.1 Write-only registers

Table 17 gives a short description of the write-only registers.

Table 17. Write-only registers

HEX code	DEC code	Description
0x00	0	FUNCTIONAL_MODE
0x01	1	B_COUNTER
0x02	2	A_COUNTER
0x03	3	REF_DIVIDER
0x04	4	CONTROL
0x05	5	CALIBRATION

### **FUNCTIONAL\_MODE**

MSB LSB

b7		b6	b5	b4	b3	b2	b1	b0
	OUTBUF_CTRL_EN	CAL_AUTOSTART_EN	PD4	PD3	PD2	PD1	PD0	B11

OUTBUF\_CTRL\_EN: Output buffer control mode enable (0 = Off; 1 = ON)

CAL\_AUTOSTART\_EN: VCO calibration auto-restart enable (0 = Off; 1 = ON)

The bits PD[4:0] allow to select different functional modes for the STW81103 synthesizer according to the *Table 18*.

Table 18. Functional modes

Decimal value PD[6:0]	Description				
0	Power down mode				
1	Enable VCO A, output frequency divided by 2				
2	Enable VCO B, output frequency divided by 2				
3	Enable external VCO, output frequency divided by 2				
4	Enable VCO A, output frequency divided by 4				
5	Enable VCO B, output frequency divided by 4				
6	Enable external VCO, output frequency divided by 4				
7	Enable VCO A, direct output				
8	Enable VCO B, direct output				
9	Enable external VCO, direct output				

STW81103 I<sup>2</sup>C bus interface

### **B\_COUNTER**

MSB	LSB

b7	b6	b5	b4	b3	b2	b1	b0
B10	В9	B8	B7	В6	B5	B4	В3

B[10:3]. B counter value (bit B11 in the previous register, bits B[2:0] in the next register)

### **A\_COUNTER**

MSB

b7	b6	b5	b4	b3	b2	b1	b0
B2	B1	В0	A4	А3	A2	A1	A0

Bits B[2:0] for B\_COUNTER, A\_COUNTER values.

### **REF\_DIVIDER**

MSB

b7	b6	b5	b4	b3	b2	b1	b0
R9	R8	R7	R6	R5	R4	R3	R2

Reference clock divider ratio R[9:1] (bits R1, R0 in the next register).

#### CONTROL

MSB

b7	b6	b5	b4	b3	b2	b1	b0
R1	R0	PLL_A1	PLL_A0	CPSEL2	CPSEL1	CPSEL0	PSC_SEL

The CONTROL register is used to set the charge pump current, the VCO output voltage amplitude and the prescaler modulus:

PLL\_A[1:0]: VCO amplitude

CPSEL[2:0]: charge pump output current

PSC\_SEL: prescaler modulus select ('0' for P=16, '1' for P=19)

The LO output frequency is programmed by setting the proper values for A, B and R according to the following formula:

$$F_{OUT} = D_R \times (B \times P + A) \times \frac{F_{REF-CLK}}{R}$$

where D<sub>B</sub> equals

f for direct output

0.5 for output divided by 2

0.25 for output divided by 4

and P is the selected prescaler modulus.

I<sup>2</sup>C bus interface STW81103

#### **CALIBRATION**

MSB

b7	b6	b5	b4	b3	b2	b1	b0
INITCAL	SERCAL	SELEXTCAL	CAL4	CAL3	CAL2	CAL1	CAL0

This register controls the VCO calibrator using the following values:

INITCAL: for test purposes only, must be set to 0

SERCAL: at 1 starts the VCO auto-calibration (automatically reset to 0 at the end of calibration)

SELEXTCAL: for test purposes only; must be set to 0 CAL[4:0]: for test purposes only; must be set to 0

### 6.3.2 Read-only register

MSB

b7	b6	b5	b4	b3	b2	b1	b0
DEV_ID1	DEV_ID0	LOCK_DET	INTCAL4	INTCAL3	INTCAL2	INTCAL1	INTCAL0

This register is automatically addressed in the 'current byte address read mode', using the following values:

DEV\_ID[1:0]: device identifier bits; returns '10'

LOCK\_DET: 1 when PLL is locked

INTCAL[4:0]: internal value of the VCO control word

### 6.3.3 Default configuration

At power on, all the bits are set to '0'. Consequently the part starts in power down mode.

STW81103 I<sup>2</sup>C bus interface

### 6.4 VCO calibration procedure

Calibration of the VCO center frequency is activated when the SERCAL bit (CALIBRATION register bit[6]) is set to 1.

To program the device properly while ensuring VCO calibration, perform the following steps before every channel change:

- 1. Program all the registers using a multi-byte write sequence with the desired settings (functional mode, B and A counters, R counter, VCO amplitude, charge pump, prescaler modulus), and all the bits of the CALIBRATION register (05H) set to 0.
- 2. Program the CALIBRATION register using a single-byte write sequence (subaddress 05H) with the SERCAL bit set to 1.

The maximum allowed PFD frequency ( $F_{PFD}$ ) during calibration is 1 MHz; if you want a  $F_{PFD}$  higher than 1 MHz, perform the following additional steps:

- Perform all the steps of the calibration procedure, making sure to program the desired VCO frequency with proper settings for the R, B and A counters so that  $F_{PED}$  is  $\leq 1$  MHz.
- Program the device with the desired VCO and PFD frequency settings according to step 1) above.

### 6.4.1 VCO calibration auto-restart feature

The VCO calibration auto-restart feature can be enabled in two steps:

- 1. set the desired frequency ensuring VCO calibration as described above (section 6.4)
- 2. program the FUNCTIONAL\_MODE register (sub-address 00H) using a single-byte write sequence with the CAL\_AUTOSTART\_EN bit set to '1' while keeping unchanged the others.

SPI digital interface STW81103

## 7 SPI digital interface

### 7.1 General features

The SPI digital interface is selected by hardware connection of pin #21 (DBUS\_SEL) to 3.3 V.

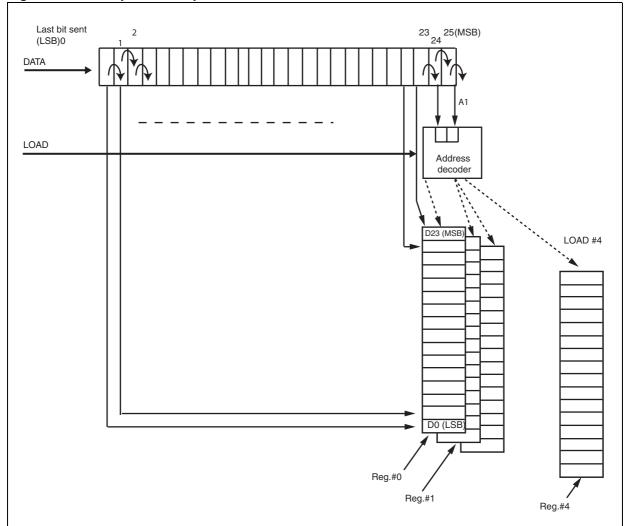
The STW81103 IC is programmed by means of a high-speed serial-to-parallel interface with write option only. The 3-wire bus can be clocked at a frequency as high as 100 MHz to allow fast programming of the registers containing the data for RF IC configuration.

The chip is programmed through serial words with a full length of 26 bits. The first 2 MSBs represent the address of the registers, and the 24 LSBs represent the value of the registers.

Each data bit is stored in the internal shift register on the rising edge of the CLOCK signal.

The outputs of the selected register are sent to the device on the **rising edge** of the LOAD signal.

Figure 26. SPI input and output bit order



STW81103 SPI digital interface

Table 19. SPI data structure (MSB is sent first)

MSB

Add	ress		Data for register (24 bits)																						
A1	A0	D23	D22	D21	D20	D19	D18	D17	D16	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

Table 20. Address decoder and outputs

Address		Outputs						
<b>A</b> 1	<b>A</b> 0	DATABITS D23-D0	No	Name	Function			
0	0	24	0	ST1	Reference divider, VCO amplitude, VCO calibration, charge pump current, prescaler modulus			
0	1	24	1	ST2	Functional modes, VCO dividers			
1	0	24	2	ST3	Reserved			
1	1	24	3	ST4	Reserved			

## 7.2 Timing specification

Figure 27. SPI timing specification

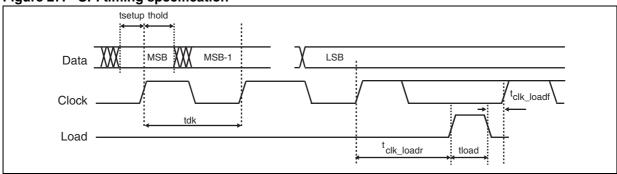


Table 21. SPI timing specification

Symbol	Parameter	Min.	Тур.	Max.	Units
t <sub>setup</sub>	DATA to CLOCK setup time	0.8			ns
t <sub>hold</sub>	DATA to CLOCK hold time	0.2			ns
t <sub>clk</sub>	CLOCK cycle period	10			ns
t <sub>load</sub>	LOAD pulse width	3			ns
t <sub>clk_loadr</sub>	CLOCK to LOAD rising edge	2			ns
t <sub>clk_loadf</sub>	CLOCK to LOAD falling edge	0.5			ns

SPI digital interface STW81103

## 7.3 Bit tables

Table 22. Bits at 00h and ST1

Seri	ial interface address = 00h	Register name = ST1				
Bit	Name	Description				
[23]	R9					
[22]	R8					
[21]	R7					
[20]	R6					
[19]	R5	Reference clock divider ratio				
[18]	R4	- heleferice clock divider fallo				
[17]	R3					
[16]	R2					
[15]	R1					
[14]	R0					
[13]	PLL_A1	VCO amplitude control				
[12]	PLL_A0	- VCO amplitude control				
[11]	CPSEL2					
[10]	CPSEL1	Charge pump output current control				
[9]	CPSEL0					
[8]	PSC_SEL	Prescaler modulus select (0 for P=16, 1 for P=19)				
[7]	INITCAL	For test purposes only; must be set to 0				
[6]	SERCAL	Enable VCO calibration (see Section 7.4)				
[5]	SELEXTCAL	For test purposes only; must be set to '0'				
[4]	CAL4					
[3]	CAL3					
[2]	CAL2	For test purposes only; must be set to '0'				
[1]	CAL1					
[0]	CAL0					

STW81103 SPI digital interface

Table 23. Bits at 01h and ST2

Seria	l interface address = 01h	Register name = ST2				
Bit	Name	Description				
[23]	OUTBUF_CTRL_EN	Output buffer control mode enable (0 = Off, 1 = On)				
[22]	CAL_AUTOSTART_EN	VCO calibration auto restart enable (0 = Off, 1 = On)				
[21]	PD4	Device functional modes:				
[20]	PD3	<ul><li>0. Power down</li><li>1. Enable VCO A, output frequency divided by 2</li></ul>				
[19]	PD2	2. Enable VCO B, output frequency divided by 2     3. Enable external VCO, output frequency divided by 2				
[18]	PD1	4. Enable VCO A, output frequency divided by 4				
[17]	PD0	<ul> <li>5. Enable VCO B, output frequency divided by 4</li> <li>6. Enable external VCO, output frequency divided by 4</li> <li>7. Enable VCO A, direct output</li> <li>8. Enable VCO B, direct output</li> <li>9. Enable external VCO, direct output</li> </ul>				
[16]	B11					
[15]	B10					
[14]	B9					
[13]	B8					
[12]	B7					
[11]	B6	D. COUNTED bits				
[10]	B5	B_COUNTER bits				
[9]	B4					
[8]	B3					
[7]	B2					
[6]	B1					
[5]	В0					
[4]	A4					
[3]	A3					
[2]	A2	A_COUNTER bits				
[1]	A1					
[0]	A0					

SPI digital interface STW81103

The LO output frequency is programmed by setting the proper value for A, B and R according to the following formula:

$$F_{OUT} = D_R \times (B \times P + A) \times \frac{F_{REF-CLK}}{R}$$

where D<sub>R</sub> equals

1 for direct output

0.5 for output divided by 2

0.25 for output divided by 4

and P is the selected prescaler modulus.

### 7.3.1 Default configuration

At power on, all the bits are set to '0'. Consequently the part starts in power down mode.

### 7.4 VCO calibration procedure

Calibration of the VCO center frequency is activated when the SERCAL bit (ST1 register bit[6]) is set to 1.

To program the device properly while ensuring VCO calibration, perform the following steps before every channel change:

- Program the ST2 register with the desired settings (functional mode, B and A counters).
- 2. Program the ST1 register with the desired settings (R counter, VCO amplitude, charge pump, prescaler modulus) and with the SERCAL bit set to 1.

The maximum allowed PFD frequency ( $F_{PFD}$ ) during calibration is 1 MHz; if you want a  $F_{PFD}$  higher than 1 MHz, perform the following additional steps:

- Perform all the steps (step 1 and 2 above) of the calibration procedure, making sure to program the desired VCO frequency with proper settings of the R, B and A counters so that  $F_{PFD}$  is  $\leq 1$  MHz.
- Program the device with the desired VCO and PFD frequency settings as per steps 1 and 2 above with SERCAL bit set to 0.

### 7.4.1 VCO calibration auto-restart feature

The VCO calibration auto-restart feature can be enabled in two steps:

- 1. Set the desired frequency ensuring VCO calibration as described above (Section 7.4)
- 2. Program the ST2 register with the CAL\_AUTOSTART\_EN bit set to '1' while keeping unchanged the others.

## 8 Application information

The STW81103 features three different alternately selectable bands: direct output (2.5 to 3.05 GHz and 4.35 to 5.0 GHz), divided by 2 (1.25 to 1.525 GHz and 2.175 to 2.5 GHz) and divided by 4 (625 to 762.5 MHz and 1087.5 to 1250 MHz). To achieve a suitable power level, a good matching network is necessary to adapt the output stage to a  $50\Omega$  load. Moreover, since most commercial RF components have single-ended input and output terminations, a differential to single-ended conversion may be required.

The different matching configurations shown below for each of the three bands are suggested as a guideline when designing your own application board.

Inside the evaluation kit is the ADS design for each matching configuration suggested in this chapter. The name of the corresponding ADS design is given in each figure.

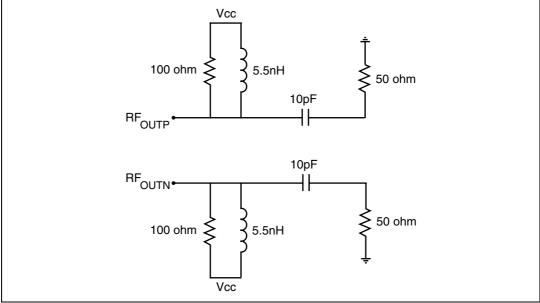
The ADS designs provide only a first indication of the output stage matching, and should be reworked according to the choices of layout, board substrate, components and so on.

The ADS designs of the evaluation boards are provided with a complete electromagnetic modelling (board, components, and so on).

## 8.1 Direct output

If you do not need a differential to single conversion, you can match the output buffer of the STW81103 in the simple way shown in *Figure 28*. This illustrates the differential to single-ended output network in the 2.5 - 5.0 GHz range (MATCH\_LC\_LUMP\_4G\_DIFF.dsn).

Figure 28. Differential/single-ended output network (MATCH\_LC\_LUMP\_4G\_DIFF.dsn)



Since most discrete components for microwave applications are single-ended, you can easily use one of the two outputs and terminate the other one to  $50\Omega$  with a 3 dB power loss.

577

Alternatively, you can combine the two outputs in other ways. A first topology for the direct output (2.5 to 5.0 GHz) is suggested in *Figure 29*. It basically consists of a simple LC balun and a matching network to adapt the output to a  $50\Omega$  load. The two LC networks shift output signal phase of -90° and +90°, thus combining the two outputs. This topology, designed for a center frequency of 4 GHz, is intrinsically narrow-band since the LC balun is tuned at a single frequency. If the application requires a different sub-band, the LC combiner can be easily tuned to the frequency of interest.

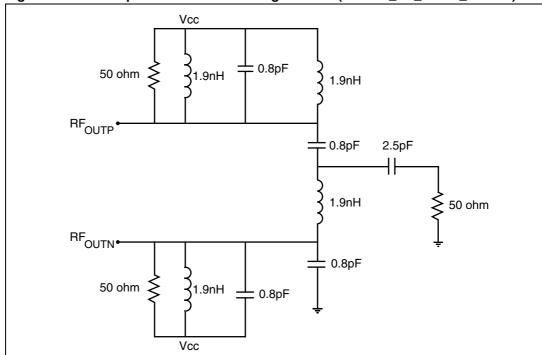


Figure 29. LC lumped balun and matching network (MATCH\_LC\_LUMP\_4G.dsn)

The 1.9 nH shunt inductor works as a DC feed for one of the open collector terminals as well as a matching element along with the other components. The 1.9 nH series inductors are used to resonate the parasitic capacitance of the chip.

For optimum output matching, it is recommended to use 0402 Murata or AVX capacitors and 0403 or 0604 HQ Coilcraft inductors. It is also advisable to use short interconnection paths to minimize losses and undesired impedance shift.

An alternative topology that permits a more broadband matching as well as balanced to unbalanced conversion, is shown in *Figure 30*.

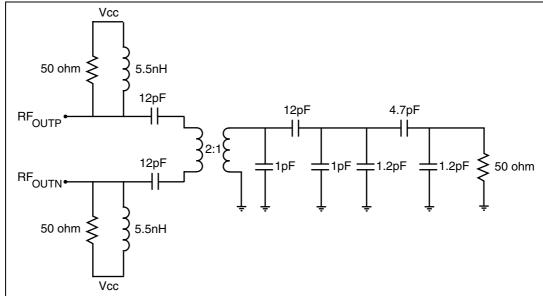


Figure 30. Evaluation board (EVB4G) matching network (MATCH\_EVB4G.dsn)

For differential to single conversion, the 50 to  $100\Omega$  Johanson balun is recommended (3700BL15B100).

## 8.2 Divided by 2 output

If your application does not require a balanced to unbalanced conversion, the output matching reduces to the simple circuit shown below (*Figure 31*), which illustrates a differential to single-ended output network in the 1.25 - 2.5 GHz range (MATCH\_LC\_LUMP\_2G\_DIFF.dsn). You can easily use this solution to provide one single-ended output that terminates the other output at  $50\Omega$  with a 3 dB power loss.

TO ohm

So ohm

So ohm

RFOUTP

10pF

RFOUTN

22nH

50 ohm

22nH

50 ohm

50 ohm

22nH

50 ohm

Figure 31. Differential/single-ended output network (MATCH\_LC\_LUMP\_2G\_DIFF.dsn)

A first solution to combine the differential outputs is the lumped LC type balun tuned in the 2 GHz band (*Figure 32*).

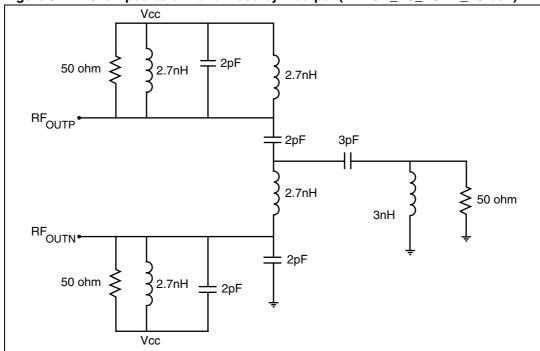


Figure 32. LC lumped balun for divided by 2 output (MATCH\_LC\_LUMP\_2G.dsn)

The same recommendation for the SMD components also applies to the divided by 2 output.

Another topology suited to combining the two outputs for the divided by 2 frequencies is represented in *Figure 33*.

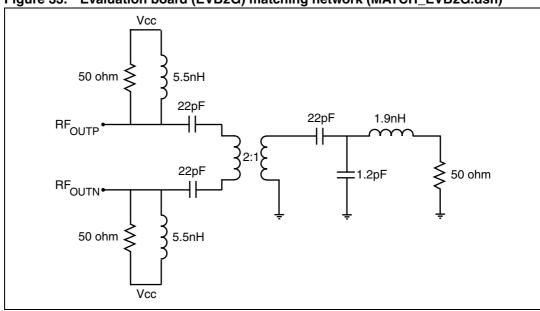


Figure 33. Evaluation board (EVB2G) matching network (MATCH\_EVB2G.dsn)

For differential to single conversion, the 50 to  $100\Omega$  Johanson balun (1600BL15B100) is recommended.

#### **Divided by 4 output** 8.3

The topology, components, values and considerations of Figure 31 also apply to the divided by 4 output (MATCH\_LC\_LUMP\_1G\_DIFF.dsn).

As for the previous sections, a solution to combine the differential outputs is the lumped LC type balun tuned in the 1 GHz band (Figure 34).

Vcc 25 ohm 5.5nH = 4pF 5.5nH RF<sub>OUTP</sub> 4pF 6pF 5.5nH 14nH 50 ohm RF<sub>OUTN</sub> 4pF 25 ohm 5.5nH : 4pF Vcc

Figure 34. LC lumped balun for divided by 4 output (MATCH\_LC\_LUMP\_1G.dsn)

If you prefer to use an RF balun, you can adapt the topology depicted in Figure 33, and change the balun and the matching components (Figure 35). The suggested balun for the 0.625 - 1.25 GHz frequency range is the 1:1 Johanson 900BL15C050.

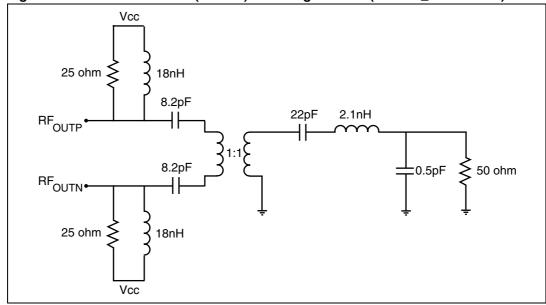


Figure 35. Evaluation board (EVB1G) matching network (MATCH EVB1G.dsn)

### 8.4 Evaluation kit

An evaluation kit can be delivered upon request, including the following:

- Evaluation board
- GUI (graphical user interface) to program the device
- Measured S parameters of the RF output
- ADS2005 schematics providing guidelines for application board design
- STWPLLSim software for PLL loop filter design and noise simulation
- Application programming interface (API)

Three different evaluation kits are available, each optimized for one of the following frequency ranges:

- 1 GHz
- 2 GHz
- 4 GHz

When ordering, please specify one of the following order codes:

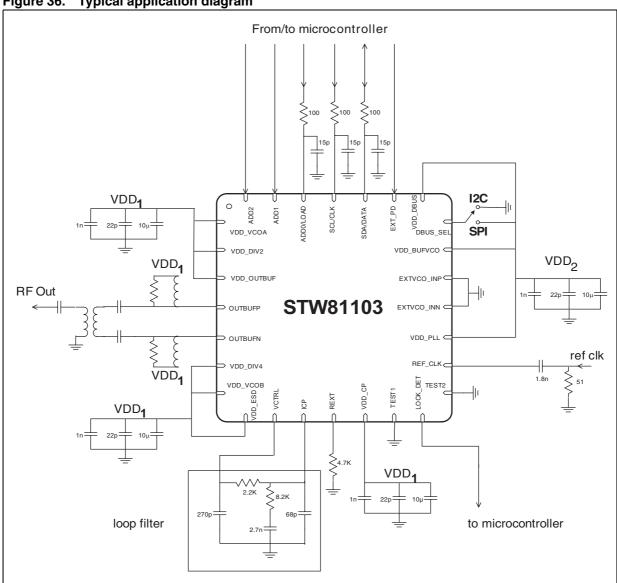
Table 24. Order code of the evaluation kit

Part number	Description
STW81103-EVB1G	1 GHz frequency range - divider by 4 output optimized
STW81103-EVB2G	2 GHz frequency range - divider by 2 output optimized
STW81103-EVB4G	4 GHz frequency range - direct output optimized

The three evaluation kits differ only for the output stage network and can be adapted from one frequency band variant to a different one replacing properly the matching components and the balun.

#### **Application diagram** 9

Figure 36. Typical application diagram



See Section 8: Application information for further information on output matching topology. Note:

- EXT\_PD, ADD2, ADD1 (and ADD0 when the I<sup>2</sup>C bus is selected) can be hard wired directly 2 on the board.
- 3 Loop filter values are for  $F_{STEP} = 200 \text{ kHz}$ .
- For best performance VDD<sub>1</sub> must be a low noise supply (20  $\mu$ V<sub>RMS</sub> in 10 Hz-100 kHz BW).

577

Application diagram STW81103

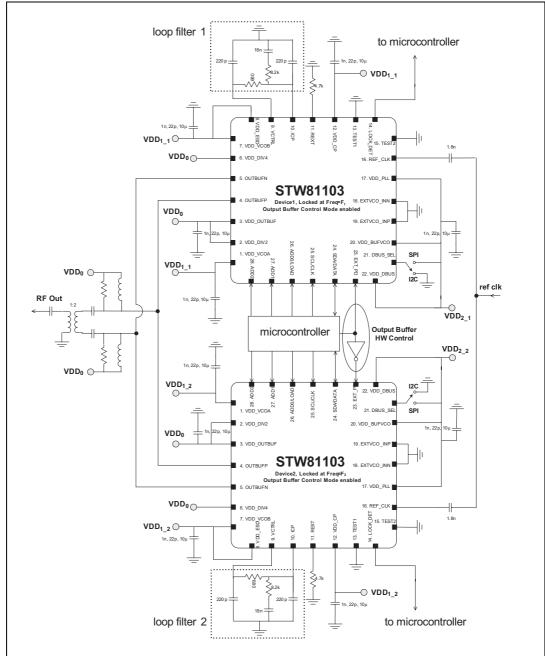


Figure 37. Ping-pong architecture diagram

Note: 1 See Section 8: Application information for further information on output matching topology.

- 2 EXT\_PD, ADD2, ADD1 (and ADD0 when the  $l^2C$  bus is selected) can be hard wired directly on the board.
- 3 Loop filter values are for  $F_{STEP} = 200 \text{ kHz}$ .
- 4 For best performance  $VDD_{1\_1}$  and  $VDD_{1\_2}$  must be low noise supplies (20  $\mu V_{RMS}$  in 10 Hz-100 KHz BW).

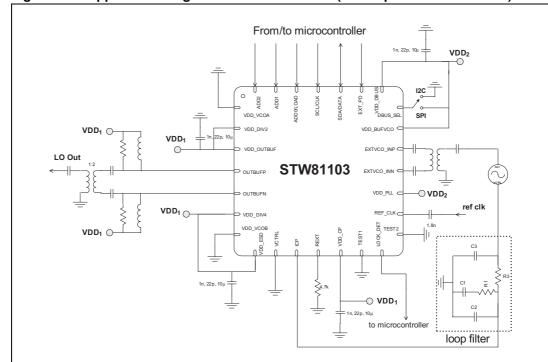


Figure 38. Application diagram with external VCO (LO output from STW81103)

Note: See Section 8: Application information for further information on output matching topology.

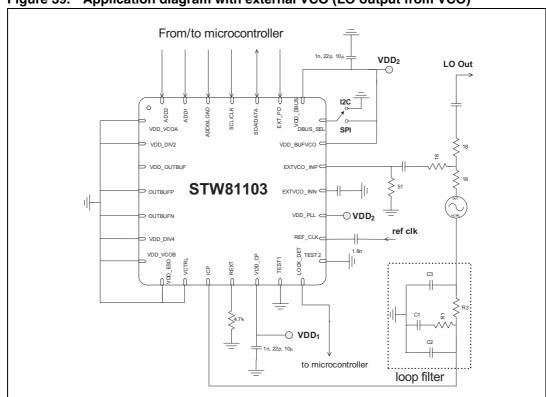


Figure 39. Application diagram with external VCO (LO output from VCO)

## 10 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK<sup>®</sup> packages, which have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark.

ECOPACK specifications are available at: http://www.st.com.

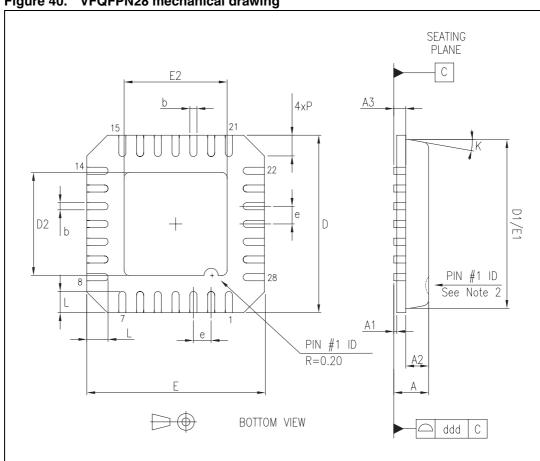


Figure 40. VFQFPN28 mechanical drawing

Note: 1 VFQFPN stands for Thermally Enhanced Very thin Fine pitch Quad Flat Package No lead. (Very thin: A=1.00 Max)

2 Details of the terminal 1 identifier are optional, but if given, must be located on the top surface of the package by using either a mold or marked features.

Table 25. Package dimensions

Ref.	Min.	Тур.	Max.	Unit
А	0.800	0.900	1.000	mm
A1		0.020	0.050	mm
A2		0.650	1.000	mm
A3		0.200		mm
b	0.180	0.250	0.300	mm
D	4.850	5.000	5.150	mm
D1		4.750		mm
D2	2.950	3.100	3.250	mm
E	4.850	5.000	5.150	mm
E1		4.750		mm
E2	2.950	3.100	3.250	mm
е		0.500		mm
L	0.350	0.550	0.750	mm
Р			0.600	mm
К			14	degrees
ddd			0.080	mm

Ordering information STW81103

# 11 Ordering information

Table 26. Order codes

Part number	Temp range, ° C	Package	Packing
STW81103AT	-40 to 85	VFQFPN28	Tray
STW81103ATR	-40 to 85	VFQFPN28	Tape and reel

# 12 Revision history

Table 27. Document revision history

Date	Revision	Changes
18-Jul-2007	1	Initial release.
14-Aug-2007	2	Added Chapter 8: Application information. Modified Section 6.4: VCO calibration procedure, and pin #23 description in Table 1.
28-Mar-2008	3	Updated Table 1: Pin description.  Updated Table 2: Absolute maximum ratings, Table 3: Operating conditions, Table 5: Electrical specifications and Table 6: Phase noise specification.  Updated Section 5.8.2: VCO frequency calibration.  Added VCO calibration auto-restart feature.  Updated Section 5.8.3: VCO voltage amplitude control.  Added Section 5.9: Output stage and Section 5.10: External VCO buffer.  Updated FUNCTIONAL_MODE and CALIBRATION registers.  Added Section 6.3: Default configuration.  Updated Section 6.4: VCO calibration procedure and added Section 6.4.1: VCO calibration auto-restart feature.  Updated Table 23: Bits at 01h and ST2.  Added Section 7.3.1: Default configuration.  Updated Section 7.4: VCO calibration procedure and added Section 7.4.1: VCO calibration auto-restart feature.  Added Section 7.7: VCO calibration auto-restart feature.  Added 'Application program interface API' item in Section 8.4.  Modified notes after Figure 36.  Added Figure 37, Figure 38 and Figure 39.  Modified Figure 40.

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